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PPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/652,677	08/29/2003	James E. Boyle	3816.04-D3	2556
22337 75	90 09/22/2005		EXAMINER	
LAW OFFICES OF CHARLES GUENZER			OMGBA, ESSAMA	
P O BOX 60729 PALO ALTO,			ART UNIT	PAPER NUMBER
,			3726	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
	10/652,677	BOYLE ET AL.					
Office Action Summary	Examiner	Art Unit	•				
	Essama Omgba	3726					
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply							
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).							
Status							
<ul> <li>1) ⊠ Responsive to communication(s) filed on 30 June 2005.</li> <li>2a) ⊠ This action is FINAL. 2b) □ This action is non-final.</li> <li>3) □ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.</li> </ul>							
Disposition of Claims							
<ul> <li>4) Claim(s) 1-30 is/are pending in the application.</li> <li>4a) Of the above claim(s) is/are withdrawn from consideration.</li> <li>5) Claim(s) is/are allowed.</li> <li>6) Claim(s) 1,4-10,13-25 and 27-30 is/are rejected.</li> <li>7) Claim(s) 2,3,11,12 and 26 is/are objected to.</li> <li>8) Claim(s) are subject to restriction and/or election requirement.</li> </ul>							
Application Papers							
<ul> <li>9) The specification is objected to by the Examiner.</li> <li>10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).</li> <li>11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.</li> </ul>							
Priority under 35 U.S.C. § 119							
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>							
Attachment(s)    Notice of References Cited (PTO-892)   Notice of Draftsperson's Patent Drawing Review (PTO-948)   Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)   Paper No(s)/Mail Date	4) Interview Summary ( Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:	te	-152)				

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#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1 and 8-10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Niemirowski et al. (US Patent 6,056,123) in view of Hewitt (US Patent 4,504,224) and Beyaert et al. (US Patent 6,361,313).

With regards to claims 1 and 10, Niemirowski et al. discloses a support tower for supporting wafers in parallel spaced relationship along a vertical axis and a method of fabricating the support tower, wherein a plurality of slots 5 are cut in each of a plurality of silicon legs 1 to form teeth therebetween, the plurality of silicon legs extending along a vertical axis, and opposite ends of the plurality of silicon legs are joined to respective ones of two silicon bases 2, see column 2, lines 19-21, 26-31, 61-67 and column 2, lines 1-20. Niemirowski et al. does not disclose the teeth having both upper and lower surfaces extending outwardly from axially extending portions of the legs at upwardly sloping angle of between 1° and 3° with respect to the vertical axis. However Hewitt teaches such upwardly slopping teeth, see column 2, lines 44-56 and figure 1. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have provided the support tower of Niemirowski et al. with teeth having both upper and lower surfaces with an upwardly sloping angle as taught by

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Hewitt, in order to minimize the area of contact therewith. Although Hewitt does not disclose the sloping angle to be between 1° and 3°, however it is known to provide teeth on support towers with such sloping angle as attested by Beyaert et al., see column 6, lines 31-35 and figure 4B. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have provided the support tower of Niemirowski et al./Hewitt with teeth having an upwardly sloping angle between 1° and 3° as taught by Beyaert et al., in order to realize the benefits of using such sloping angle.

For claim 8, Applicant should note that such wedge-shaped teeth are well known to those of ordinary skill in the art.

For claim 9, see column 3, lines 6-8 of Niemirowski et al.

3. Claims 4, 7 and 13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Niemirowski et al./Hewitt/Beyaert et al. as applied to claims 1 and 10 above, and further in view of Ohsawa (US Patent 6,033,215).

For claims 4 and 13, Niemirowski et al./Hewitt/Beyaert et al. discloses a wafer support tower and a method of fabricating a wafer support tower as shown above except for support surfaces extending perpendicularly to the vertical axis being formed on the first sides of the teeth at their distal ends. However Ohsawa teaches such support surfaces, see figure 7. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have formed the teeth of the support tower of Niemirowski et al./Hewitt/Beyaert et al. with support surfaces extending perpendicularly to the vertical axis, in light of the teachings of Ohsawa, in order to securely seat the wafers.

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For claim 7, Applicant should note that such wedge-shaped teeth are well known to those of ordinary skill in the art.

4. Claim 5 is rejected under 35 U.S.C. 103(a) as being unpatentable over Niemirowski et al./Hewitt/Beyaert et al./Ohsawa as applied to claim 4 above, and further in view of Ballance et al. (US Patent 6,395,363).

Niemirowski et al./Hewitt/Beyaert et al./Ohsawa discloses a support tower as shown above except for the support surfaces being polished. However it is known to polish substrate support surfaces as attested by Ballance et al., see column 2, lines 66-67 and column 3, lines 1-11. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have polished the support surfaces of the support tower of Niemirowski et al./Hewitt/Beyaert et al./Ohsawa, in light of the teachings of Ballance et al., in order to reduce the tendency of the support to scratch the substrate surface.

5. Claim 6 is rejected under 35 U.S.C. 103(a) as being unpatentable over Niemirowski et al./Hewitt/Beyaert et al./Ohsawa as applied to claim 4 above, and further in view of Wingo (US Patent 6,171,400).

Niemirowski et al./Beyaert et al./Ohsawa discloses a support tower as shown above except for the support surfaces supporting the wafers at places located at between 69% and 72% of a radius of the wafers. However it is known to support wafers at such places as attested by Wingo, see column 4, lines 53-58. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have designed the teeth of the support tower of Niemirowski et al./Beyaert et

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al./Ohsawa such that the wafers are supported at places located at between 69% and 72% of a radius of the wafers, in light of the teachings of Wingo, in order to provide effective support to the wafers.

6. Claims 14, 15, 17-20, 22, 24, 25 and 27-29 are rejected under 35 U.S.C. 103(a) as being unpatentable over Niemirowski et al. in view of Hewitt, Beyaert et al. and Ohsawa.

With regards to claims 14, 15, 19, 20, 24, 25 and 29, Niemirowski et al. discloses a support tower for supporting wafers in parallel spaced relationship along a vertical axis and a method of fabricating the support tower, wherein a plurality of slots 5 are cut in each of a plurality of silicon legs 1 to form teeth therebetween, the plurality of silicon legs extending along a vertical axis, and opposite ends of the plurality of silicon legs are joined to respective ones of two silicon bases 2, see column 2, lines 19-21, 26-31, 61-67 and column 2, lines 1-20. Niemirowski et al. does not disclose the teeth having both upper and lower surfaces extending outwardly from axially extending portions of the legs at upwardly sloping angle of between 1° and 3° with respect to the vertical axis. However Hewitt teaches such upwardly slopping teeth, see column 2, lines 44-56 and figure 1. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have provided the support tower of Niemirowski et al. with teeth having both upper and lower surfaces with an upwardly sloping angle as taught by Hewitt, in order to minimize the area of contact therewith. Although Hewitt does not disclose the sloping angle to be between 1° and 3°, however it is known to provide teeth on support towers with such sloping angle as attested by Beyaert et al.,

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see column 6, lines 31-35 and figure 4B. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have provided the support tower of Niemirowski et al./Hewitt with teeth having an upwardly sloping angle between 1° and 3° as taught by Beyaert et al., in order to realize the benefits of using such sloping angle. Niemirowski et al./Hewitt/Beyaert et al. does not disclose support surfaces extending perpendicularly to the vertical axis being formed on the first sides of the teeth at their distal ends, however Ohsawa teaches such support surfaces, see figure 7. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have formed the teeth of the support tower of Niemirowski et al./Hewitt/Beyaert et al. with support surfaces extending perpendicularly to the vertical axis, in light of the teachings of Ohsawa, in order to securely seat the wafers.

For claims 17, 18, 27 and 28, Applicant should note that legs formed of quartz or silicon carbide members are old and well known to those of ordinary skill in the art.

For claim 22, Applicant should note that such wedge-shaped teeth are well known to those of ordinary skill in the art.

7. Claims 21 and 30 are rejected under 35 U.S.C. 103(a) as being unpatentable over Niemirowski et al/Hewitt/Beyaert et al./Ohsawa as applied to claims 14 and 24 above, and further in view of Wingo.

Niemirowski et al./Hewitt/Beyaert et al./Ohsawa discloses a support tower as shown above except for the support surfaces supporting the wafers at places located at between 69% and 72% of a radius of the wafers. However it is known to support wafers

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at such places as attested by Wingo, see column 4, lines 53-58. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have designed the teeth of the support tower of Niemirowski et al./Hewitt/Beyaert et al./Ohsawa such that the wafers are supported at places located at between 69% and 72% of a radius of the wafers, in light of the teachings of Wingo, in order to provide effective support to the wafers.

8. Claim 23 is rejected under 35 U.S.C. 103(a) as being unpatentable over Niemirowski et al./Hewitt/Beyaert et al./Ohsawa as applied to claim 13 above, and further in view of Ballance et al.

Niemirowski et al./Hewitt/Beyaert et al./Ohsawa discloses a support tower as shown above except for the support surfaces being polished. However it is known to polish substrate support surfaces as attested by Ballance et al., see column 2, lines 66-67 and column 3, lines 1-11. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made, to have polished the support surfaces of the support tower of Niemirowski et al./Hewitt/Beyaert et al./Ohsawa, in light of the teachings of Ballance et al., in order to reduce the tendency of the support to scratch the substrate surface. Applicant should note that it is inherent that the portions of the teeth polished in Niemirowski et al./Hewitt/Beyaert et al./Ohsawa/Balance et al. will be the ones in a plane perpendicular to the first axis since it is that portion that support the wafers.

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## Allowable Subject Matter

9. Claims 2, 3, 11, 12 and 26 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

### Response to Arguments

10. Applicant's arguments with respect to claims 1, 4-10, 13-25 and 27-30 have been considered but are most in view of the new ground(s) of rejection.

#### **Conclusion**

11. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

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12. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Essama Omgba whose telephone number is (571) 272-4532. The examiner can normally be reached on M-F 9-6:30, 1st Friday off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David Bryant can be reached on (571) 272-4526. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Essama Omgba
Primary Examiner
Art Unit 3726

eo

September 19, 2005